

AO3400A

N-Channel Enhancement Mode Field Effect Transistor



General Description

The AO3400A/L uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. This device is suitable for use as a load switch or in PWM applications. AO3400A and AO3400AL are electrically identical.

- -RoHS Compliant
- -AO3400AL is Halogen Free

Features

 $V_{DS}(V) = 30V$

 $I_D = 5.7A \ (V_{GS} = 10V)$

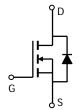
 $R_{DS(ON)} < 26.5 \text{m}\Omega \text{ (V}_{GS} = 10 \text{V)}$

 $R_{DS(ON)}$ < 32m Ω (V_{GS} = 4.5V)

 $R_{DS(ON)}$ < 48m Ω (V_{GS} = 2.5V)

Rg,Ciss,Coss,Crss Tested





-55 to 150

Absolute Maximum Ratings T _A =25°C unless otherwise noted							
Parameter		Symbol	Maximum	Units			
Drain-Source Voltage		V_{DS}	30	V			
Gate-Source Voltage		V_{GS}	±12	V			
Continuous Drain	T _A =25°C		5.7	Δ.			
Current AF	T _A =70°C	I _D	4.7	7 A			
Pulsed Drain Current ^B		I _{DM}	25	Α			
	T _A =25°C	В	1.4	W			
Power Dissipation	T _A =70°C	$$ P_D	0.9				
	-						

Thermal Characteristics								
Parameter	Symbol Typ Max		Units					
Maximum Junction-to-Ambient A	t ≤ 10s	D	70	90	°C/W			
Maximum Junction-to-Ambient A	Steady-State	$ R_{\theta JA}$	100	125	°C/W			
Maximum Junction-to-Lead ^C	Steady-State	$R_{ heta JL}$	63	80	°C/W			

 T_J, T_{STG}

Junction and Storage Temperature Range

°C

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	rameter Conditions		Min	Тур	Max	Units	
STATIC F	PARAMETERS							
BV_{DSS}	Drain-Source Breakdown Voltage	I _D =250uA, V _{GS} =0V		30			V	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V				1	uA	
	Zero Gate Voltage Drain Gurrent		T _J =125°C			5	uA	
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±12V				100	nA	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=250\mu A$		0.7	1	1.5	V	
$I_{D(ON)}$	On state drain current	V _{GS} =4.5V, V _{DS} =5V		25			Α	
R _{DS(ON)}	Static Drain-Source On-Resistance	V_{GS} =10V, I_D =5.7A			22	26.5		
			T _J =125°C		31	38	m()	
		V _{GS} =4.5V, I _D =5A			25.4	32	mΩ	
		V_{GS} =2.5 V , I_{D} =3 A		34	48			
g FS	Forward Transconductance	V _{DS} =5V, I _D =5.7A			26		S	
V_{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V			0.72	1.0	V	
Is	Maximum Body-Diode Continuous Curre			2.0	Α			
DYNAMIC	PARAMETERS							
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =15V, f=1MHz			900	1100	pF	
C _{oss}	Output Capacitance				88		pF	
C _{rss}	Reverse Transfer Capacitance				65		pF	
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz			0.95	1.5	Ω	
SWITCHI	NG PARAMETERS							
Q_g	Total Gate Charge	V _{GS} =4.5V, V _{DS} =15V, I _D =5.7A			10	13	nC	
Q_{gs}	Gate Source Charge				1.8		nC	
Q_{gd}	Gate Drain Charge				3.75		nC	
t _{D(on)}	Turn-On DelayTime				3.2		ns	
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =15V, R_L =2.6 Ω , R_{GEN} =3 Ω			3.5		ns	
$t_{D(off)}$	Turn-Off DelayTime				21.5		ns	
t _f	Turn-Off Fall Time				2.7		ns	
t _{rr}	Body Diode Reverse Recovery Time	IF=5.7A, dl/dt=100A/us			16.8	20	ns	
Q_{rr}	Body Diode Reverse Recovery Charge	IF=5.7A, dl/dt=100A/us			8		nC	

A: The value of R_{BJA} is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design.

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B: Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ =150°C.

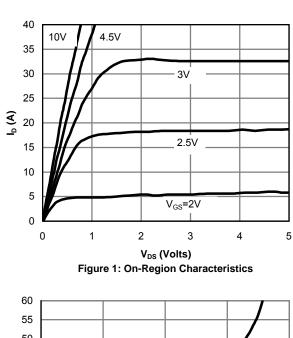
C. The $R_{\theta JA}$ is the sum of the thermal impedence from junction to lead $R_{\theta JL}$ and lead to ambient.

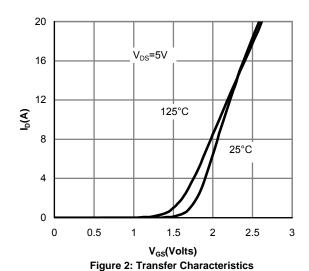
D. The static characteristics in Figures 1 to 6 are obtained using <300 us pulses, duty cycle 0.5% max.

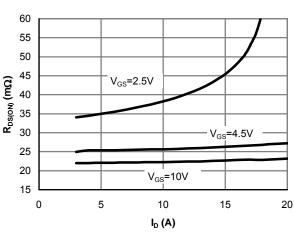
E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T A=25°C. The SOA curve provides a single pulse rating.

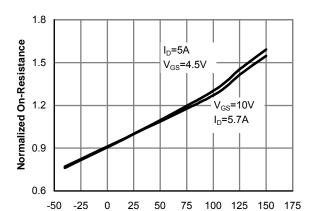
F: The current rating is based on the $t \le 10s$ thermal resistance rating. Rev1:May. 2008

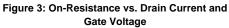
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



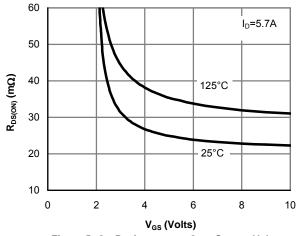








Temperature (°C) Figure 4: On-Resistance vs. Junction Temperature



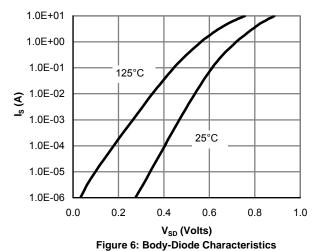


Figure 5: On-Resistance vs. Gate-Source Voltage

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

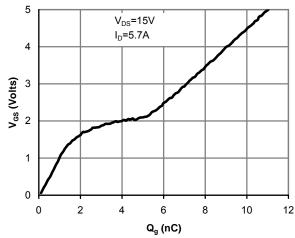


Figure 7: Gate-Charge Characteristics

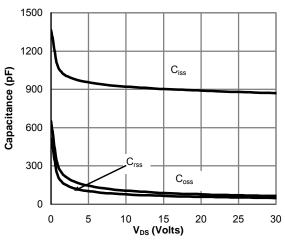


Figure 8: Capacitance Characteristics

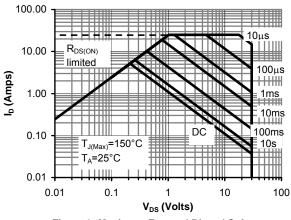


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

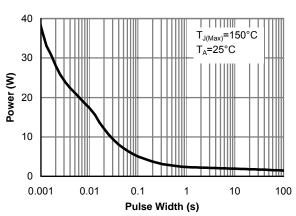


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

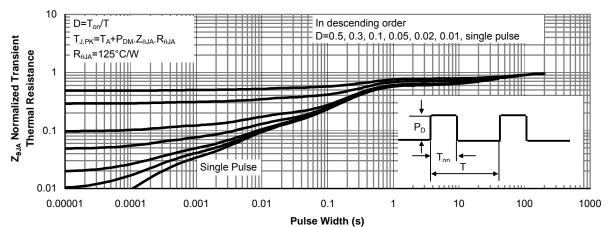


Figure 11: Normalized Maximum Transient Thermal Impedance